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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/519,991	01/04/2005	Shinichi Ishibashi	Q85552	Q85552 9188	
23373 759	-		EXAMINER		
SUGHRUE MION 2100 PENNSYLV	'ANIA AVENUE, N.W.		ROSASCO, STEPHEN D		
SUITE 800 WASHINGTON, DC 20037			ART UNIT	PAPER NUMBER	
			1756		
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SHORTENED STATUTORY P	ERIOD OF RESPONSE	MAIL DATE	DEI IVERY MODE		
3 MONT	HS	02/27/2007	PAP	ER	

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

	Application No.	Applicant(s)	
	10/519,991	ISHIBASHI ET AL.	
Office Action Summary	Examiner	Art Unit	<u> </u>
	Stephen Rosasco	1756	
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence addres	S
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 16(a). In no event, however, may a reply be tirn iill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this commun D (35 U.S.C. § 133).	
Status			
Responsive to communication(s) filed on <u>27 Ja</u> This action is FINAL . 2b) ☑ This Since this application is in condition for allowan closed in accordance with the practice under E	action is non-final. ce except for formal matters, pro		rits is
Disposition of Claims			
4) Claim(s) 1-12 is/are pending in the application. 4a) Of the above claim(s) 9-11 is/are withdrawn 5) Claim(s) is/are allowed. 6) Claim(s) 1-8 and 12 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or			
Application Papers			
 9) The specification is objected to by the Examiner 10) The drawing(s) filed on <u>04 January 2005</u> is/are: Applicant may not request that any objection to the of Replacement drawing sheet(s) including the correction 11) The oath or declaration is objected to by the Examiner 	a)⊠ accepted or b)□ objected drawing(s) be held in abeyance. See on is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priori application from the International Bureau * See the attached detailed Office action for a list of	have been received. have been received in Application ty documents have been received (PCT Rule 17.2(a)).	on Noed in this National Stag	e
Attachment(s) Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date 1/4/05.	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa	te	

Detailed Action

Applicant's election without traverse of Group I (claims 1-8 and 12) in the reply filed on 12/27/06 is acknowledged.

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claim 1 is rejected under 35 U.S.C. 102(e) as being anticipated by Yan (7,118,832).

Yan teaches (see claims 1-18) a reflective mask having an inspection contrast of greater than about 30% up to about 90%, for ultraviolet inspection light, the reflective mask comprising a reflector; and a plurality of absorber regions masking portions of the reflector, the absorber regions each including: absorber material comprising tantalum nitride; buffer material positioned between a first side of the absorber material and the reflector; and an anti-reflective coating comprising silicon nitride and positioned to cover a second side of the absorber material opposite the first side.

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a

Application/Control Number: 10/519,991

Art Unit: 1756

person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-8 and 12 are rejected under 35 U.S.C. 103(a) as being unpatentable over Stivers et al. (6,410,193) in view of Yan et al. (6,610,447) and Yan et al. (6,607,862).

The claimed invention is directed to a reflective mask blank comprising a substrate, and a multilayer reflective film for reflecting an exposure light and an absorber layer for absorbing the exposure light, which are formed on said substrate in the order named, said reflective mask blank characterized in that said absorber layer has a layered structure comprising at least an uppermost layer and a lower layer other than it, and said uppermost layer exhibits a reflectance of 20% or less with respect to a light having an inspection wavelength for use in an inspection of an absorber layer pattern formed in said absorber layer and further is formed of an inorganic material having a resistance against an etching condition in forming a pattern in said lower layer.

The applicant discusses the limitations of the prior art in that if a difference in reflectance with respect to the wavelength of the inspection light is small between the surface of the buffer layer or the surface of the multilayer reflective film and the surface of the absorber layer, the contrast in the inspection becomes poor so that the accurate inspection cannot be achieved.

In the claimed invention an object is to obtain a reflective mask wherein a fine pattern can be formed in an absorber layer with high accuracy in shape, such that a sufficient contrast can be achieved in a pattern inspection.

Stivers et al. teach a reflective mask having non-reflective and reflective regions, said reflective regions reflective of light at an inspection wavelength and a semiconductor

Application/Control Number: 10/519,991

Art Unit: 1756

processing wavelength, said non-reflective regions being less reflective of said first light and said second light than said reflective regions in order to create:

1) a first image with a contrast greater than 0.210 and that is formed by reflecting said first light off of said reflective mask; and 2) a second image with a contrast greater than 0.750 and that is formed by reflecting said second light off of said reflective mask.

And wherein said semiconductor processing wavelength is within the EUV spectrum and said inspection wavelength is within the DUV spectrum.

The teachings of Stivers et al. differ from those of the applicant in that the applicant teaches that the absorber is made of multi layers of Ta and Si.

Yan et al. '447 teach a reflective mask comprising a buffer layer and absorber and wherein the absorber layer can be multilayered – see DETX (41): The improved absorber layer 2400 may include one type of material or may be a stack of different materials. Variation in the layer, if desired, may be continuous or may be discrete with distinct interfaces. For example, in one embodiment, the improved absorber layer 2400 is a TaxNy film or Tantalum doped with Nitrogen in which x=1 and y<:0.6. In another embodiment, the improved absorber layer 2400 is Tantalum Nitride (TaN) in which the stoichiometry changes through the thickness of the film.

Yan et al. '862 teach that the absorptive layer comprises silicon germanium, tantalum, or tantalum nitride.

It would have been obvious to one having ordinary skill in the art to take the teachings of Stivers et al. and combine them with the teachings of Yan et al. '447 and Yan et al. '862 in order to make the claimed invention because it would have been obvious to choose the prior art combination of materials that would produce the desired etch contrast.

Art Unit: 1756

Conclusion

Any inquiry concerning this communication or earlier communications from the Examiner should be directed to Stephen Rosasco whose telephone number is (571) 272-1389. The Examiner can normally be reached Monday-Friday, from 8:00 AM to 4:30 PM. The Examiner's supervisor, Mark Huff, can be reached on (571) 272-1385. The fax phone number for the organization where this application or proceeding is assigned is (571) 273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

S. Rosasco

Primary Examiner

Art Unit 1756

S.Rosasco 2/12 /07